onsemi

Small Signal Diode

BAS31

ABSOLUTE MAXIMUM RATINGS ($T_A = 25^{\circ}C$, unless otherwise noted) (Note 1, 2)

Symbol		Ratings	Unit		
V _{RRM}	Maximum Repetitive Reverse Voltage		120	V	
I _{F(AV)}	Average Rectified Forward Current		200	mA	
I _{FSM}	Non–Repetitive Peak Forward	Pulse Width = 1.0 second	1.0	А	
	Surge Current	Pulse Width = 1.0 microsecond	2.0		
T _{STG}	Storage Temperature Range		–55 to +150	°C	
TJ	Operating Junction Temperature		150	°C	

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. These ratings are based on a maximum junction temperature of 150°C.

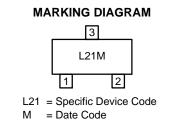
2. These are steady-state limits. **onsemi** should be consulted on applications involving pulsed or low- duty-cycle operations.

THERMAL CHARACTERISTICS ($T_A = 25^{\circ}C$, unless otherwise noted)

Symbol	Parameter	Ratings	Unit
PD	Power Dissipation	350	°C/W
R _{0JA}	Thermal Resistance, Junction-to-Ambient	357	



CASE 318BM







ORDERING INFORMATION

Device	Package	Reel	Shipping [†]
BAS31	SOT-23 3L (Pb-Free,	7"	3000 / Tape & Reel
BAS31-D87Z	Halide Free)	13"	10000 / Tape & Reel

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, <u>BRD8011/D</u>.

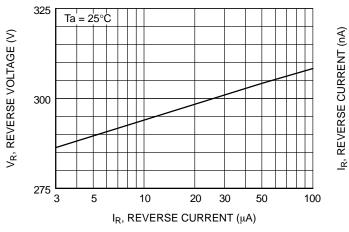
ELECTRICAL CHARACTERISTICS (T_J = 25°C unless otherwise noted)

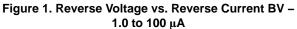
Symbol	Parameter	Conditions	Min	Max	Unit
V _R	Breakdown Voltage	I _R = 1.0 mA	120	-	V
VF	Forward Voltage	I _F = 10 mA	-	750	mV
		I _F = 50 mA	-	840	mV
		I _F = 100 mA	-	900	mV
		I _F = 200 mA	-	1.00	V
		I _F = 400 mA	-	1.25	V
I _R	Reverse Current	V _R = 90 V	-	100	nA
		$V_R = 90 V, T_A = 150^{\circ}C$	-	100	μΑ
CT	Total Capacitance	V _R = 0 V, f = 1.0 MHz	-	35	pF
t _{rr}	Reverse Recovery Time	I_F = I_R = 30 mA, I_{RR} = 3.0 mA, R_L = 100 Ω	_	50	ns

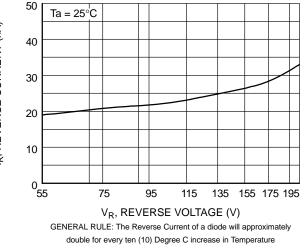
Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

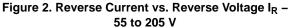
BAS31

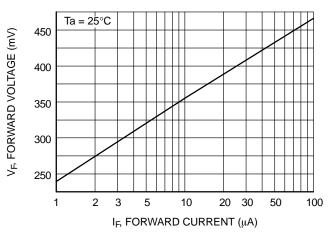
TYPICAL PERFORMANCE CHARACTERISTICS

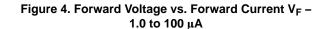


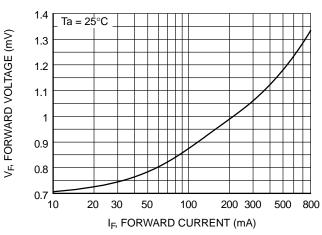


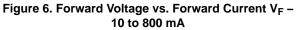


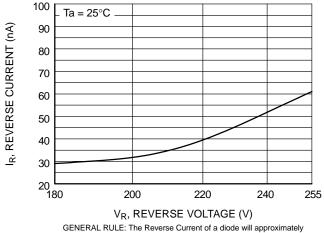




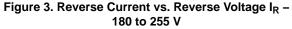


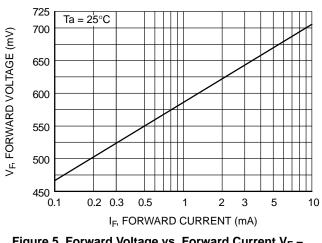


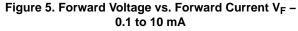




double for every ten (10) Degree C increase in Temperature

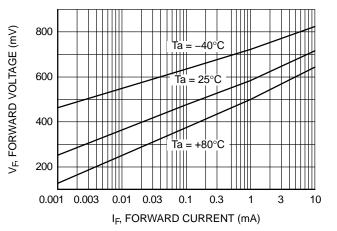


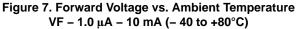




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TYPICAL PERFORMANCE CHARACTERISTICS (CONTINUED)





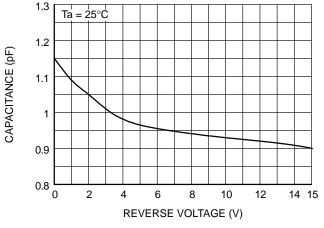
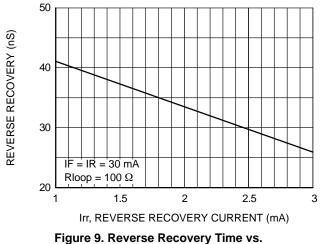
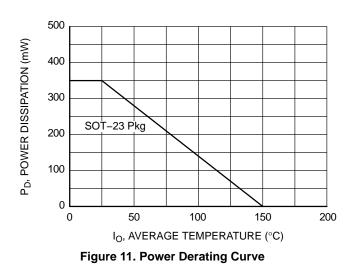


Figure 8. Capacitance vs. Reverse Voltage



Reverse Recovery Current (Irr)



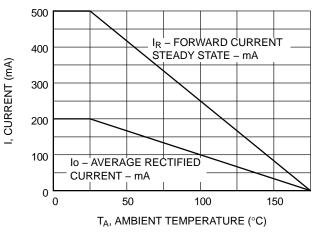


Figure 10. Average Rectified Current (I_0) and Forward Current (I_F) vs. Ambient Temperature (T_A)

SOT-23 CASE 318BM **ISSUE A** DATE 01 SEP 2021 NOTES: UNLESS OTHERWISE SPECIFIED А D A) REFERENCE JEDEC REGISTRATION 3 TO-236, VARIATION AB, ISSUE H. В B) ALL DIMENSIONS ARE IN MILLIMETERS. C) DIMENSIONS ARE INCLUSIVE OF BURRS, MOLD FLASH AND TIE BAR EXTRUSIONS. D) DIMENSIONING AND TOLERANCING PER E1 ASME Y14.5M - 2009. MILLIMETERS DIM SEE DETAIL A NOM. MIN. MAX. А 1.20 2 A1 0.00 0.05 0.10 (z) A2 0.93 REF b b 0.37 0 44 0.60 е ⊕ 0.20(M) A B 0.08 0.23 с 0.15 e1 D 2.72 2.92 3.12 F Е 2.10 2.40 2.70 E1 1.15 1.30 1.50 0.95 е 0.95 BSC (A2) A1 1.90 BSC e1 0.20 L --------0.10M C \square 1.40 L1 0.55 REF С z 0.29 REF GAGE PLANE 2.20 0.25 С 1 SEATING - 1.00 PLANE - (L1) -1.90 DETAIL A LAND PATTERN SCALE: 2X RECOMMENDATION *FOR ADDITIONAL INFORMATION ON OUR PB-FREE STRATEGY AND SOLDERING GENERIC DETAILS, PLEASE DOWNLOAD THE ON **MARKING DIAGRAM*** SEMICONDUCTOR SOLDERING AND MOUNTING TECHNIQUES REFERENCE MANUAL, SOLDERRM/D. XXXM-. *This information is generic. Please refer to device data sheet for actual part marking. XXX = Specific Device Code Pb-Free indicator, "G" or microdot "•", may Μ = Date Code or may not be present. Some products may = Pb-Free Package not follow the Generic Marking. Electronic versions are uncontrolled except when accessed directly from the Document Repository. **DOCUMENT NUMBER:** 98AON13784G Printed versions are uncontrolled except when stamped "CONTROLLED COPY" in red. **DESCRIPTION:** SOT-23 PAGE 1 OF 1

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